Darlington Complementary Silicon Power Transistors

This series of plastic, medium-power silicon NPN and PNP Darlington transistors are designed for general purpose and low speed switching applications.

Features

- High DC Current Gain $h_{FE} = 2500$ (typ) @ $I_C = 5.0$ Adc.
- Collector Emitter Sustaining Voltage @ 30 mAdc:

 $V_{CEO(sus)}$ = 80 Vdc (min) – BDW46 100 Vdc (min) – BDW42/BDW47

• Low Collector Emitter Saturation Voltage

 $V_{CE(sat)} = 2.0 \text{ Vdc (max)} @ I_C = 5.0 \text{ Adc}$ 3.0 Vdc (max) @ $I_C = 10.0 \text{ Adc}$

- Monolithic Construction with Built-In Base Emitter Shunt resistors
- TO-220AB Compact Package
- These are Pb-Free Packages*

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage BDW46 BDW42, BDW47	V _{CEO}	80 100	Vdc
Collector-Base Voltage BDW46 BDW42, BDW47	V _{CB}	80 100	Vdc
Emitter-Base Voltage	V _{EB}	5.0	Vdc
Collector Current	I _C	15	Adc
Base Current	Ι _Β	0.5	Adc
Total Device Dissipation @ T _C = 25°C Derate above 25°C	P _D	85 0.68	W W/°C
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-55 to +150	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance,	$R_{\theta JC}$	1.47	°C/W
Junction-to-Case			

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.



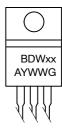
ON Semiconductor®

http://onsemi.com

15 AMP DARLINGTON COMPLEMENTARY SILICON POWER TRANSISTORS 80-100 VOLT, 85 WATT



MARKING DIAGRAM



BDWxx = Device Code

x = 42, 46, or 47

A = Assembly Location

Y = Year WW = Work Week G = Pb-Free Package

ORDERING INFORMATION

Device	Package	Shipping
BDW42G	TO-220AB (Pb-Free)	50 Units/Rail
BDW46G	TO-220AB (Pb-Free)	50 Units/Rail
BDW47G	TO-220AB (Pb-Free)	50 Units/Rail

^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Characteristic		Symbol	Min	Max	Unit
OFF CHARACTERISTICS			•		•
Collector Emitter Sustaining Voltage (Note 1)		V _{CEO(sus)}			Vdc
$(I_C = 30 \text{ mAdc}, I_B = 0)$	BDW46	` ,	80	_	
	BDW42/BDW47		100	-	
Collector Cutoff Current		I _{CEO}			mAdc
$(V_{CE} = 40 \text{ Vdc}, I_B = 0)$	BDW46		_	2.0	
$(V_{CE} = 50 \text{ Vdc}, I_B = 0)$	BDW42/BDW47		_	2.0	
Collector Cutoff Current		I _{CBO}			mAdc
$(V_{CB} = 80 \text{ Vdc}, I_{E} = 0)$	BDW46		_	1.0	
$(V_{CB} = 100 \text{ Vdc}, I_{E} = 0)$	BDW42/BDW47		-	1.0	
Emitter Cutoff Current		I _{EBO}	_	2.0	mAdc
$(V_{BE} = 5.0 \text{ Vdc}, I_{C} = 0)$					
ON CHARACTERISTICS (Note 1)					
DC Current Gain		h _{FE}			
$(I_C = 5.0 \text{ Adc}, V_{CE} = 4.0 \text{ Vdc})$			1000	_	
$(I_C = 10 \text{ Adc}, V_{CE} = 4.0 \text{ Vdc})$			250	_	
Collector-Emitter Saturation Voltage		V _{CE(sat)}			Vdc
$(I_C = 5.0 \text{ Adc}, I_B = 10 \text{ mAdc})$. ,	_	2.0	
$(I_C = 10 \text{ Adc}, I_B = 50 \text{ mAdc})$			-	3.0	
Base-Emitter On Voltage		V _{BE(on)}	_	3.0	Vdc
$(I_C = 10 \text{ Adc}, V_{CE} = 4.0 \text{ Vdc})$. ,			
SECOND BREAKDOWN (Note 2)					
Second Breakdown Collector		I _{S/b}			Adc
Current with Base Forward Biased					
BDW42	V _{CE} = 28.4 Vdc		3.0	-	
	V _{CE} = 40 Vdc		1.2	-	
BDW46/BDW47	$V_{CE} = 22.5 \text{ Vdc}$		3.8	-	
	V _{CE} = 36 Vdc		1.2	_	
DYNAMIC CHARACTERISTICS			T	T	
Magnitude of common emitter small signal short circuit current tr	ansfer ratio	f_T	4.0	-	MHz
$(I_C = 3.0 \text{ Adc}, V_{CE} = 3.0 \text{ Vdc}, f = 1.0 \text{ MHz})$					
Output Capacitance		C_{ob}			pF
$(V_{CB} = 10 \text{ Vdc}, I_{E} = 0, f = 0.1 \text{ MHz})$	BDW42		_	200	
	BDW46/BDW47			300	
Small-Signal Current Gain		h _{fe}	300	-	
$(I_C = 3.0 \text{ Adc}, V_{CE} = 3.0 \text{ Vdc}, f = 1.0 \text{ kHz})$					

^{1.} Pulse Test: Pulse Width = 300 μ s, Duty Cycle = 2.0%. 2. Pulse Test non repetitive: Pulse Width = 250 ms.

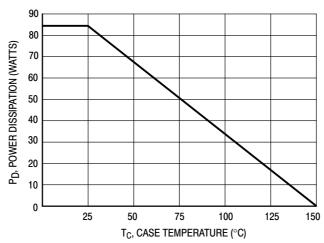


Figure 1. Power Temperature Derating Curve

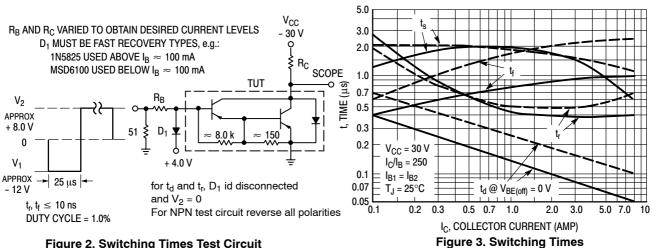


Figure 2. Switching Times Test Circuit

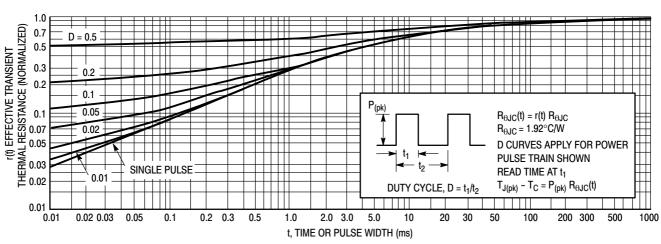
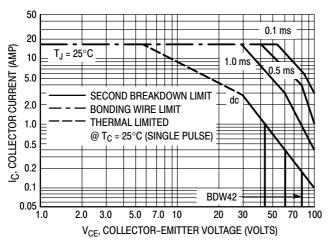


Figure 4. Thermal Response

ACTIVE-REGION SAFE OPERATING AREA





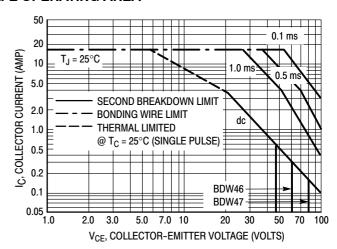


Figure 6. BDW46 and BDW47

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_C - V_{CE}$ limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate. The data of Figure 5 and 6 is based on $T_{J(pk)} = 200$ °C; T_C is variable depending on conditions.

Second breakdown pulse limits are valid for duty cycles to 10% provided $T_{J(pk)} \leq 200^{\circ}\text{C.}\ T_{J(pk)}$ may be calculated from the data in Figure 4. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown. *Linear extrapolation

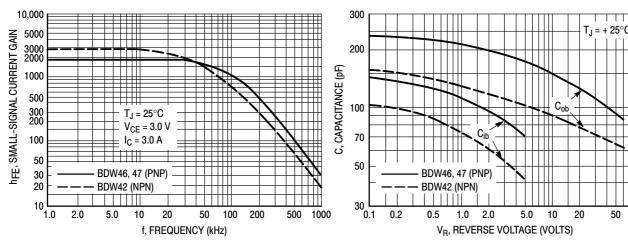


Figure 7. Small-Signal Current Gain

Figure 8. Capacitance

100

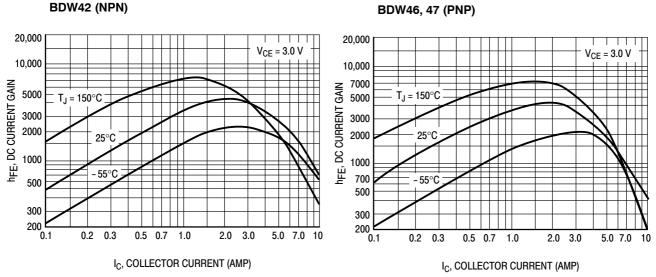


Figure 9. DC Current Gain

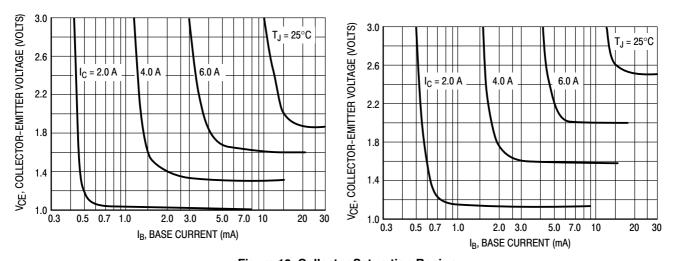


Figure 10. Collector Saturation Region

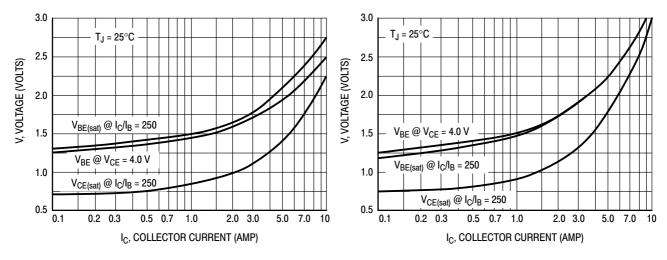


Figure 11. "On" Voltages

BDW42 (NPN)

BDW46, 47 (PNP)

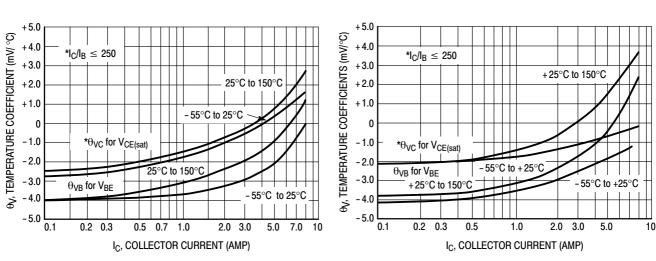


Figure 12. Temperature Coefficients

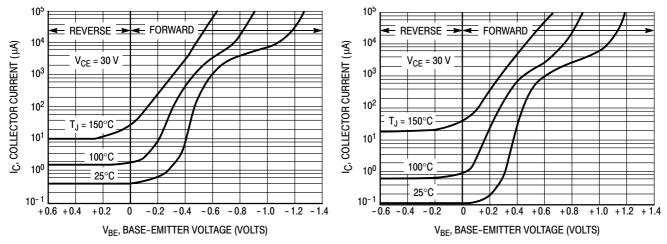


Figure 13. Collector Cut-Off Region

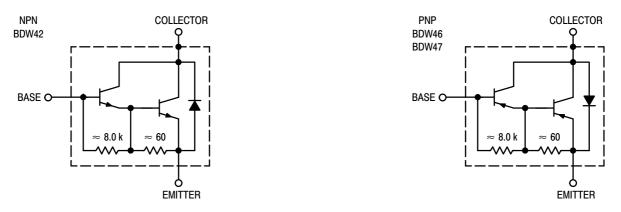
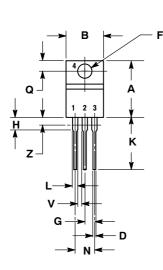
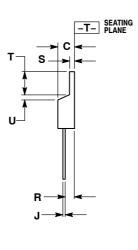


Figure 14. Darlington Schematic

PACKAGE DIMENSIONS

TO-220 CASE 221A-09 **ISSUE AG**





NOTES

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH.
- DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

	INCHES		MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.570	0.620	14.48	15.75	
В	0.380	0.405	9.66	10.28	
С	0.160	0.190	4.07	4.82	
D	0.025	0.036	0.64	0.91	
F	0.142	0.161	3.61	4.09	
G	0.095	0.105	2.42	2.66	
Н	0.110	0.161	2.80	4.10	
J	0.014	0.025	0.36	0.64	
K	0.500	0.562	12.70	14.27	
L	0.045	0.060	1.15	1.52	
N	0.190	0.210	4.83	5.33	
Q	0.100	0.120	2.54	3.04	
R	0.080	0.110	2.04	2.79	
S	0.045	0.055	1.15	1.39	
T	0.235	0.255	5.97	6.47	
U	0.000	0.050	0.00	1.27	
٧	0.045		1.15		
Z		0.080		2.04	

STYLE 1:

BASE

- COLLECTOR
- EMITTER
- COLLECTOR

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